



High-Speed CMOS 16Kx4 SRAM with Output Enable

QS8885
QS8886

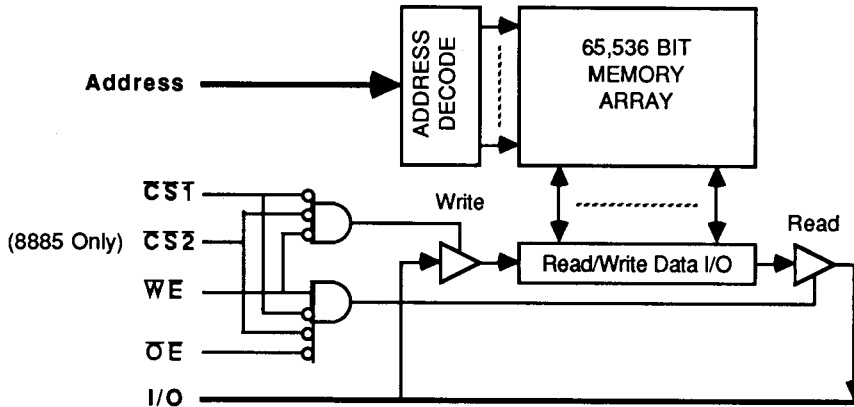
- High Speed Access and Cycle times
- 8ns/10ns/12ns/15ns/20ns/25ns Commercial
- 12ns/15ns/20ns/25ns/35ns Military
- TTL compatible I/O
- Low power, high-speed QCMOS™ technology
- Military product compliant to MIL-STD-883, Class B
- 6-Transistor cell for high reliability
- Ideal for reliable, dense memory systems
- Available in 24-pin DIPs, 24-pin ZIP, 24-pin 300 mil SOJ, 28-pin LCC & QSOP
- Low Standby current
- JEDEC standard pinout

DESCRIPTION

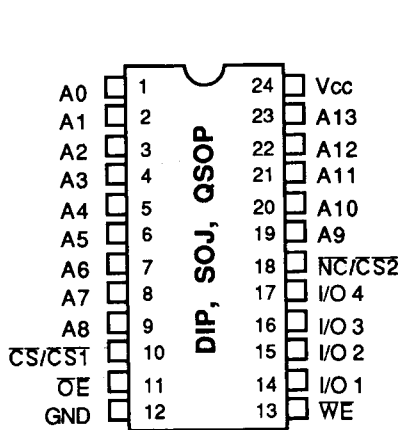
The QS8885 and QS8886 are high-speed 64K SRAMs organized as 16Kx4. The 8885 has two chip selects, and both have output enable. The 8885 and 8886 are manufactured in a high-performance CMOS process, and they are based on a 6-transistor cell design for high reliability of data retention. Their high-speed access times make them useful in cache data RAM, cache tag RAMs, high-speed scratchpad memories, look-up tables, pipelined DSP and bit-slice systems. Low operating power and excellent latch-up and ESD protection are provided.

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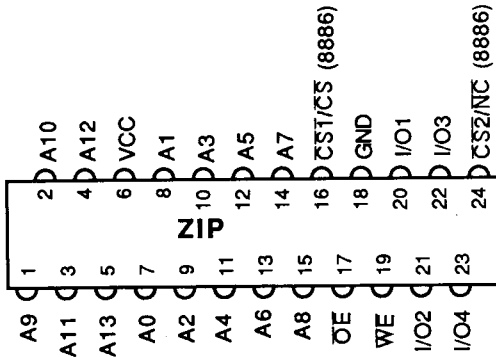
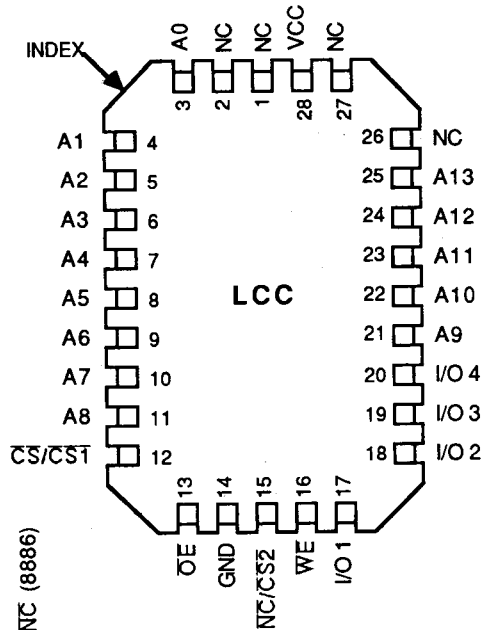
FUNCTIONAL BLOCK DIAGRAM



PIN CONFIGURATIONS



ALL PINS TOP VIEW



Note:
 Pin 10 of DIP/SOIC/ZIP and pin 12 of LCC is CS for 8886, CS1 for 8885
 Pin 18 of DIP/SOIC/ZIP and pin 15 of LCC is NC for 8886, CS2 for 8885

PIN DESCRIPTION

Pin Name	I/O	Function
A	I	Address
I/O 1-4	I/O	Data
CS, CS1/2	I	Chip Select
WE	I	Write Enable
OE	I	Output Enable

FUNCTION TABLE

CS1	CS2	WE	I/O	Power	Function
H	X	X	High Z	Standby	Deselect
X	H	X	High Z	Standby	Deselect
L	L	H	Data Out	Active	Read
L	L	L	Data In	Active	Write

ABSOLUTE MAXIMUM RATINGS

Supply Voltage to Ground..... -0.5V to +7.0V
 DC Output Voltage V_O -0.5V to $V_{CC} + 0.5V$ DC
 Input Voltage V_I -0.5V to $V_{CC} + 0.5V$
 AC Input Voltage (for a pulse width ≤ 20 ns)..... -3.0V
 DC Output Current Max. sink current/pin..... 50 mA
 DC Output Current Max. source current/pin..... 30 mA
 T_{BIAS} Temperature Under Bias, COM..... -65° to +125°C
 T_{STG} Storage Temperature, COM..... -65° to +125°C
 T_{BIAS} Temperature Under Bias, MIL..... -65° to +135°C
 T_{STG} Storage Temperature, MIL..... -65° to +155°C

Note: Stresses above those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to the maximum ratings for extended periods may affect reliability.

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CAPACITANCE

$T_a = +25^\circ\text{C}$, $f = 1$ MHz

Name	Description	Conditions	Typ	Max	Unit
Cin	Input Capacitance	$V_{in} = 0$ V PDIP Pkg.	3	6	pF
Cin	Input Capacitance	$V_{in} = 0$ V SOJ Pkg.	2.5	5	pF
Cout	Output Capacitance	$V_{out} = 0$ V PDIP Pkg.		7	pF
Cout	Output Capacitance	$V_{out} = 0$ V SOJ Pkg.		7	pF

Note: Capacitance is measured at characterization but not tested at final production.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Commercial TA = 0° C to 70°C, Vcc = 5.0V±10% Military TA = -55°C to 125° C, Vcc = 5.0V±10%

Symbol	Parameter	Test Conditions	Commercial		Military		Unit
			Min	Max	Min	Max	
Vih	Input HIGH Voltage	Logic High for All Inputs	2.2	6.0	2.2	6.0	Volts
Vil	Input LOW Voltage (1)	Logic Low for All Inputs		0.8		0.8	
Voh	Output HIGH Voltage	Ioh = -4 mA, Vcc = MIN	2.4		2.4		
Vol	Output LOW Voltage	Iol = 8 mA, Vcc = MIN		0.4		0.4	
Ii	Input Leakage	Vcc = MAX, Vin = GND to Vcc		5		10	µA
Io	Output Leakage	Vcc = MAX, Vout = GND to Vcc		5		10	

Notes:

1. Transient inputs with Vil not more negative than -3.0 volts are permitted for pulse widths < 20 ns.

POWER SUPPLY CHARACTERISTICS

Commercial TA = 0° C to 70°C, Vcc = 5.0V±10% Military TA = -55°C to 125° C, Vcc = 5.0V±10%
 Vlc = 0.2 V, Vhc = Vcc - 0.2V At f = 0, no input lines switch; At f = f MAX, RAM is cycling at 1 / t RC

Symbol	Parameter	-8		-10		-12		15		-20		-25/-35		Unit
		C	C	M	C	M	C	M	C	M	C	M		
Icc1	Static Operating Current, Vcc = MAX Outputs open CS ≤ Vil, f = 0	110	100	120	100	120	100	120	100	120	100	120	100	mA
Icc2	Dynamic Operating Current, Vcc = MAX Outputs open CS ≤ Vil, f = f MAX	160	145	165	135	155	125	145	120	140	110	130		
I _{sb}	TTL Standby Current, Vcc = MAX Outputs open CS ≥ Vih, f = f MAX	70	60	70	60	70	60	70	60	70	60	70		
I _{sb1}	Full Standby Current, Vcc = MAX Outputs open CS ≥ Vhc, f = 0 Vin ≤ Vlc or Vin ≥ Vhc	20	15	20	15	20	15	20	15	20	15	20		

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SWITCHING CHARACTERISTICS OVER OPERATING RANGE

Commercial TA = 0° C to 70°C, Vcc = 5.0V±10% Military TA = -55°C to 125° C, Vcc = 5.0V±10%
 See Read Timing Diagrams. All values in nanoseconds unless otherwise noted

Symbol	Parameter (1)	-8(3)		-10(3)		-12		-15		-20		-25		-35	
		Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max
READ CYCLE															
t RC	Read Cycle Time	8	-	10	-	12	-	15	-	19	-	25	-	35	-
t AA	Address Access Time	-	8	-	10	-	12	-	15	-	19	-	25	-	35
t ACS	Chip Select Access Time	-	8	-	10	-	12	-	15	-	19	-	25	-	35
t OH	Output Hold from Address Change	1.5	-	2	-	2	-	2	-	3	-	3	-	3	-
t CLZ	Chip Select to Output in Low Z (2)	1.5	-	2	-	2	-	2	-	2	-	2	-	3	-
t CHZ	Chip Select to Output in High Z (2)	-	4	-	4	-	5	-	7	-	8	-	10	-	15
t OE	Output Enable to Data Valid (2)	-	4	-	5	-	6	-	6	-	8	-	10	-	18
t OLZ	Output Enable to Output in Low Z (2)	1.5	-	2	-	2	-	2	-	2	-	2	-	3	-
t OHZ	Output Enable to Output in High Z (2)	-	4	-	4	-	4	-	5	-	7	-	8	-	15
t PU	Chip Select to Power Up Time (2)	0	-	0	-	0	-	0	-	0	-	0	-	0	-
t PD	Chip Select to Power Down Time (2)	8	-	10	-	12	-	15	-	19	-	25	-	35	-

Notes:

- 1) See Test Circuit and Waveforms. Minimums guaranteed but not tested.
- 2) This parameter is guaranteed by design but not tested.
- 3) For Vcc±5% Commercial Only-Preliminary Data.

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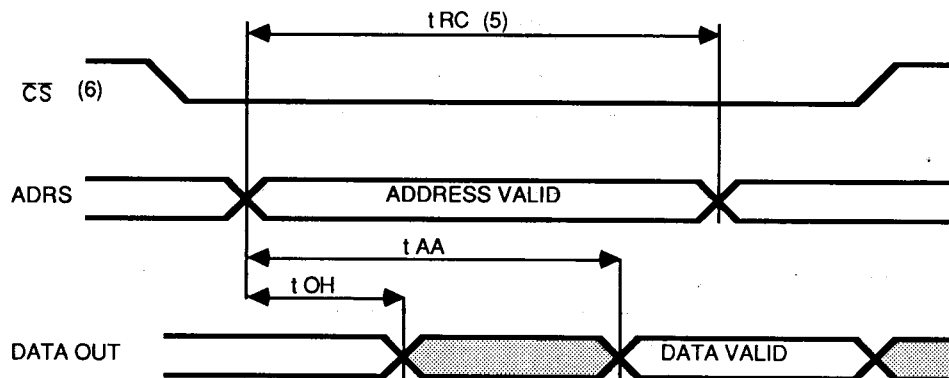
Commercial TA = 0°C to 70°C, Vcc = 5.0V±10% Military TA = -55°C to 125°C, Vcc = 5.0V±10%
 See Write Timing Diagrams. All values in nanoseconds unless otherwise noted

Symbol	Parameter (1)	-8(3)		-10(3)		-12		-15		-20		-25		-35	
		Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max
WRITE CYCLE															
t _{WC}	Write Cycle Time	8	-	10	-	12	-	15	-	19	-	25	-	35	-
t _{CW}	Chip Select Valid to End of Write	7	-	8	-	10	-	13	-	17	-	20	-	30	-
t _{AW}	Address Valid to End of Write	7	-	8	-	10	-	13	-	17	-	20	-	30	-
t _{AS}	Address Setup Time	0	-	0	-	0	-	0	-	0	-	0	-	0	-
t _{WP}	Write Pulse width	7	-	8	-	10	-	12	-	16	-	20	-	30	-
t _{WR}	Write Recovery Time	0	-	0	-	0	-	0	-	0	-	0	-	0	-
t _{DW}	Data Valid to End of Write	4	-	5	-	6	-	8	-	10	-	13	-	18	-
t _{DH}	Data Hold Time	0	-	0	-	0	-	0	-	0	-	0	-	0	-
t _{WZ}	Write Enable to Output in High Z (2)	-	4	-	4	-	5	-	6	-	7	-	8	-	12
t _{OW}	Output Active from End of Write	1.5	-	2	-	2	-	2	-	2	-	2	-	3	-

Notes:

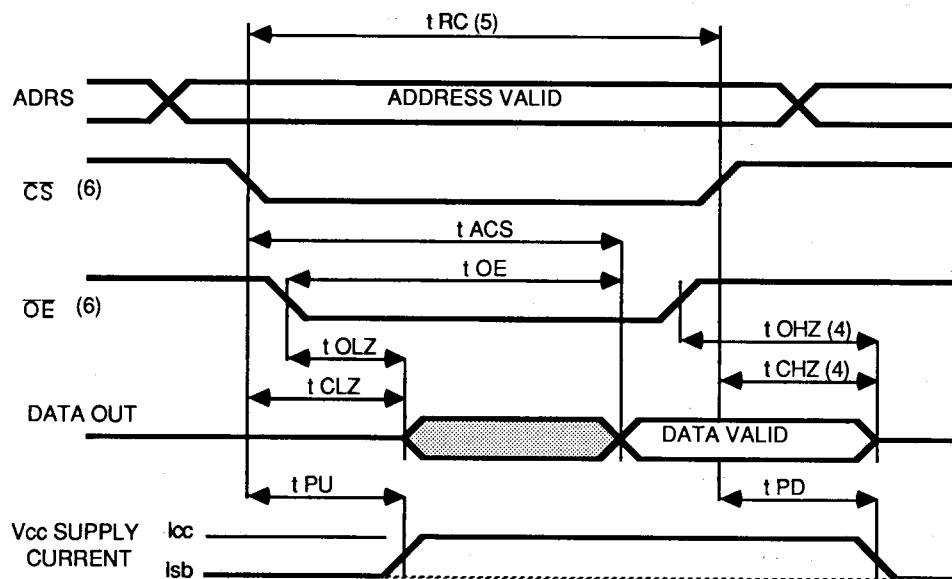
- 1) See Test Circuit and Waveforms. Minimums guaranteed but not tested.
- 2) This parameter is guaranteed by design but not tested.
- 3) For Vcc±5% Commercial Only-Preliminary Data.

TIMING WAVEFORMS - READ CYCLE NO. 1 (1,2,6)



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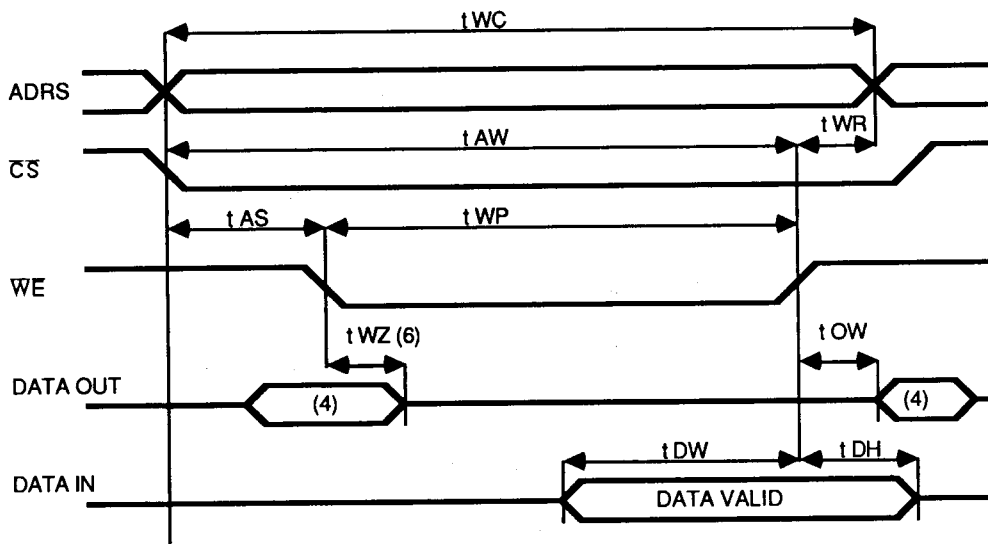
TIMING WAVEFORMS - READ CYCLE NO. 2 (1,3,6)



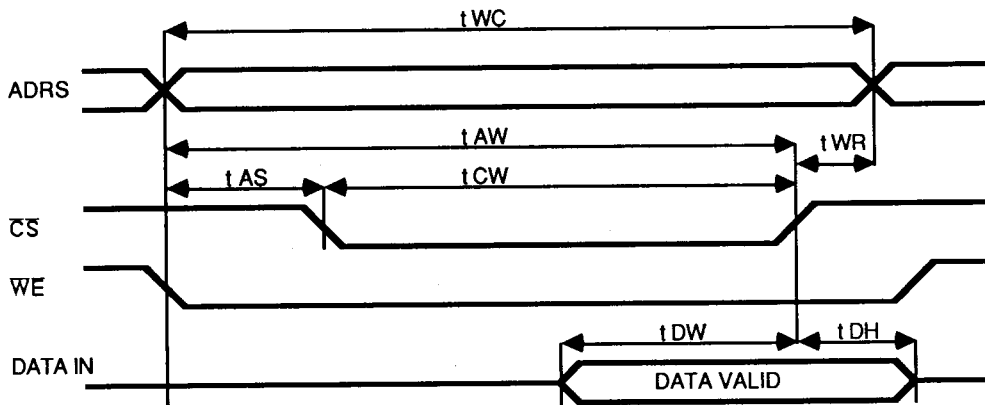
Notes:

1. WE is high for Read cycle.
2. 8886 CS is low for Read cycle #1. Both CS1 and CS2 are low for 8885.
3. Address is valid to or coincident with CS transition time for Read Cycle #2.
4. Transition to Hi-Z is measured ± 200 mV change from the prior steady state voltage.
5. All read timings are referenced from the last valid address to the first transitioning address.
6. CS applies to CS on the 8886 and the combination of CS1 and CS2 on the 8885.

TIMING WAVEFORMS-WRITE CYCLE No. 1 (1,2,3 WE controlled timing)



TIMING WAVEFORMS-WRITE CYCLE No. 2 (1,2,3,5 CS controlled timing)



Notes:

1. WE or CS must be high during address transitions.
2. A write occurs during the overlap of a low CS and a low WE.
3. t_{WR} is measured from the earlier of CS and WE going high to end of the write cycle.
4. During this period the I/O pins are in the output state and input signals must not be applied.
5. If the CS low transition occurs simultaneously with or after the WE low transition, the output remains in the high impedance state.
6. Transition to Hi-Z is measured ± 200 mV change from the previous steady state voltage.